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Z86E33/733/E34
Z86E43/743/E44

CMOS Z8® OTP Microcontrollers

Product Specification

PS022901-0508

Warning: DO NOT USE IN LIFE SUPPORT

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Revision History

Each instance in Revision History reflects a change to this document from its previous revision. For more details, refer to the corresponding pages and appropriate links in the table below.

Date	Revision Level	Description	Page No
May 2008	01	Original issue.	All

Table of Contents

Architectural Overview

Zilog's Z86E33/733/E34, E43/743/E44 8-Bit One-Time Programmable (OTP) Microcontrollers are members of Zilog's single-chip Z8® MCU family featuring enhanced wake-up circuitry, programmable Watchdog Timers, Low Noise EMI options, and easy hardware/software system expansion capability.

Four basic address spaces support a wide range of memory configurations. The designer has access to three additional control registers that allow easy access to register mapped peripheral and I/O circuits.

For applications demanding powerful I/O capabilities, the Z86E33/733/E34 have 24 pins, and the Z86E43/743/E44 have 32 pins of dedicated input and output. These lines are grouped into four ports, eight lines per port, and are configurable under software control to provide timing, status signals, and parallel I/O with or without handshake, and address/data bus for interfacing external memory.

Note: *All signals with an overline are active Low. For example, B/$\overline{W}$, for which WORD is active Low, and $\overline{B}$/W, for which BYTE is active Low.*

Power connections follow these conventional descriptions:

Connection	Circuit	Device
Power	V_{CC}	V_{DD}
Ground	GND	V_{SS}

Features

Table 1 lists the features of Z86E33/733/E34, E43/743/E44.

Table 1. Z86E33/733/E34, E43/743/E44 Features

Device	ROM (KB)	RAM[1] (Bytes)	I/O Lines	Speed (MHz)
Z86E33	4	237	24	12
Z86733	8	237	24	12
Z86E34	16	237	24	12
Z86E43	4	236	32	12
Z86743	8	236	32	12

Table 1. Z86E33/733/E34, E43/743/E44 Features (Continued)

Device	ROM (KB)	RAM[1] (Bytes)	I/O Lines	Speed (MHz)
Z86E44	16	236	32	12

[1]General-Purpose

- Standard Temperature (V_{CC} = 3.5 V to 5.5 V)
- Extended Temperature (V_{CC} = 3.5 V to 5.5 V)
- Available Packages:
  - 28-Pin DIP/SOIC/PLCC OTP (E33/733/E34)
  - 40-Pin DIP OTP (E43/743/E44)
  - 44-Pin PLCC/LQFP OTP (E43/743/E44)
- Software Enabled Watchdog Timer (WDT)
- Push-Pull/Open-Drain Programmable on Port 0, Port 1, and Port 2
- 24/32 Input/Output Lines
- Clock-Free WDT Reset
- Auto Power-On Reset (POR)
- Programmable OTP Options:
  - RC Oscillator
  - EPROM Protect
  - Auto Latch Disable
  - Permanently Enabled WDT
  - Crystal Oscillator Feedback Resistor Disable
  - RAM Protect
- Low-Power Consumption: 60 mW
- Fast Instruction Pointer: 0.75 µs
- Two Standby Modes: STOP and HALT
- Digital Inputs CMOS Levels, Schmitt-Triggered
- Software Programmable Low EMI Mode
- Two Programmable 8-Bit Counter/Timers Each with a 6-Bit Programmable Prescaler
- Six Vectored, Priority Interrupts from Six Different Sources
- Two Comparators

- On-Chip Oscillator that Accepts a Crystal, Ceramic Resonator, LC, RC, or External Clock Drive

Functional Block Diagram

Figure 1 displays the functional block diagram.

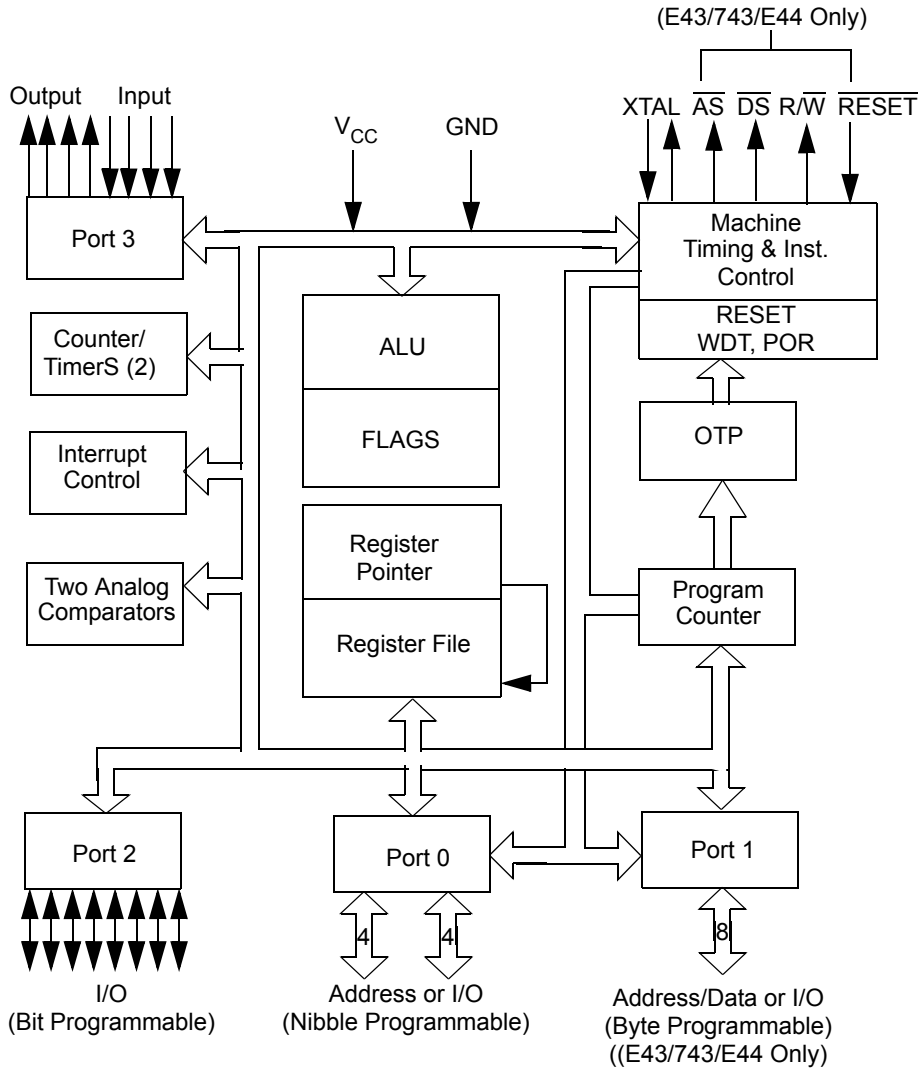

Figure 1. Functional Block Diagram

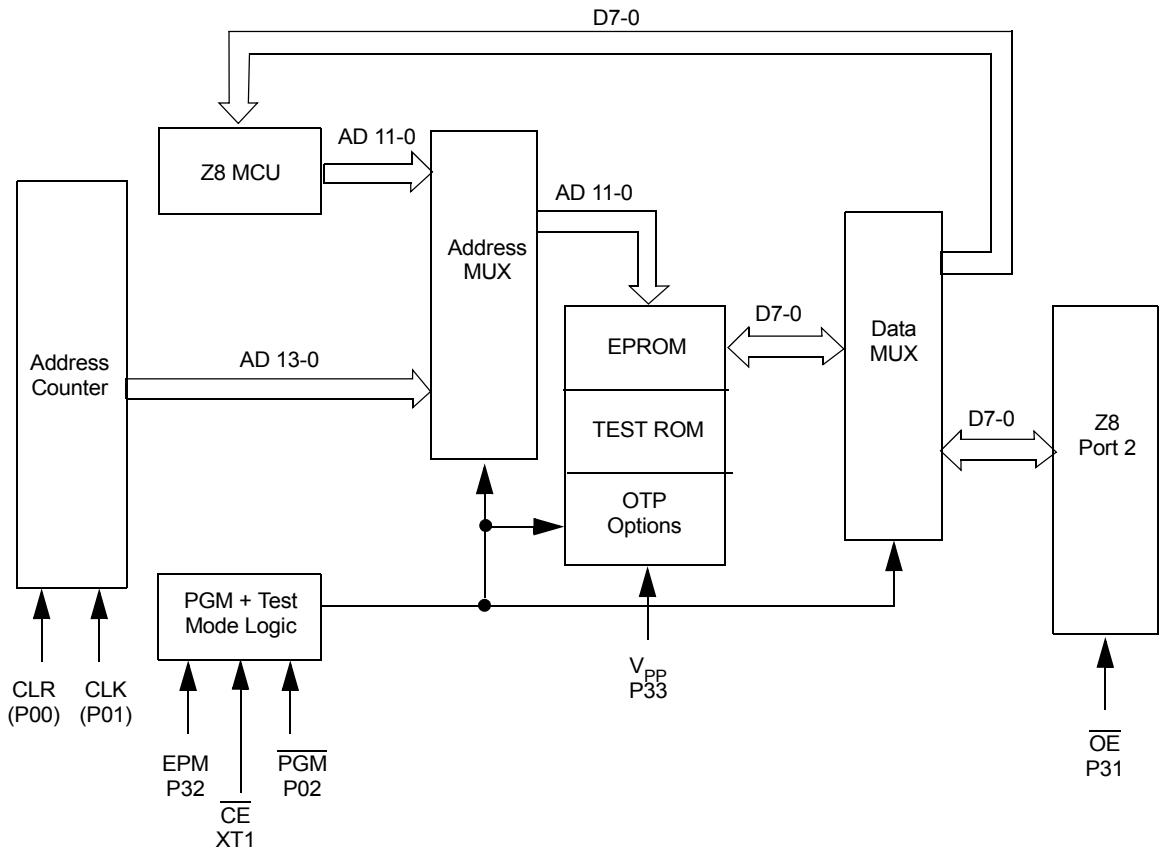

Figure 2. EPROM Programming Block Diagram

Pin Description

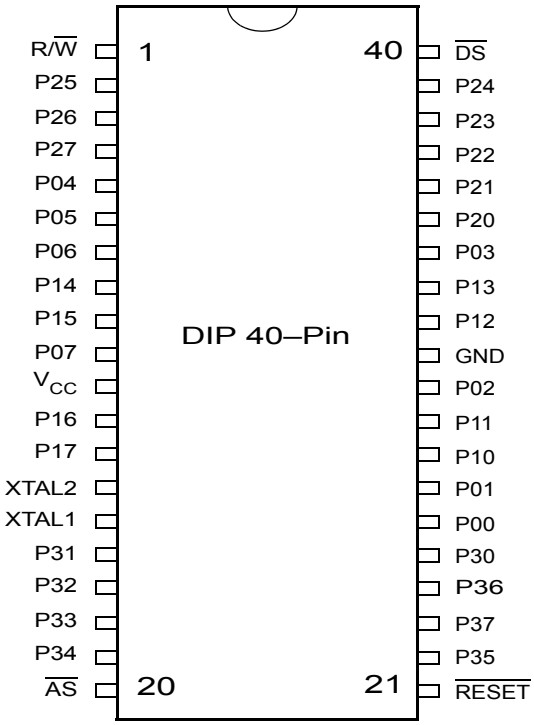

Figure 3. 40-Pin DIP Pin Configuration Standard Mode

Table 2. 40-Pin DIP Pin Identification Standard Mode

Pin No	Symbol	Function	Direction
1	R/$\overline{W}$	Read/Write	Output
2-4	P25-P27	Port 2, Pins 5,6,7	Input/Output
5-7	P04-P06	Port 0, Pins 4,5,6	Input/Output
8-9	P14-P15	Port 1, Pins 4,5	Input/Output
10	P07	Port 0, Pin 7	Input/Output
11	V_{CC}	Power Supply	
12-13	P16-P17	Port 1, Pins 6,7	Input/Output
14	XTAL2	Crystal Oscillator	Output

Table 2. 40-Pin DIP Pin Identification Standard Mode (Continued)

Pin No	Symbol	Function	Direction
15	XTAL1	Crystal Oscillator	Input
16-18	P31-P33	Port 3, Pins 1,2,3	Input
19	P34	Port 3, Pin 4	Output
20	AS	Address Strobe	Output
21	RESET	Reset	Input
22	P35	Port 3, Pin 5	Output
23	P37	Port 3, Pin 7	Output
24	P36	Port 3, Pin 6	Output
25	P30	Port 3, Pin 0	Input
26-27	P00-P01	Port 0, Pins 0,1	Input/Output
28-29	P10-P11	Port 1, Pins 0,1	Input/Output
30	P02	Port 0, Pin 2	Input/Output
31	GND	Ground	
32-33	P12-P13	Port 1, Pins 2,3	Input/Output
34	P03	Port 0, Pin 3	Input/Output
35-39	P20-P24	Port 2, Pins 0, 1,2,3,4	Input/Output
40	DS	Data Strobe	Output

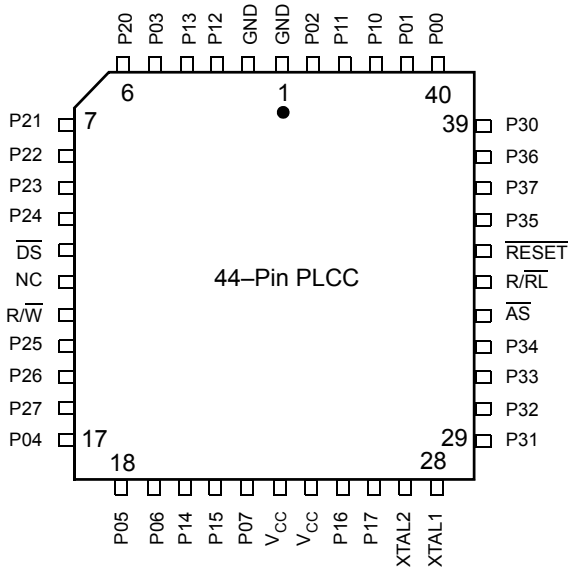

Figure 4. 44-Pin PLCC Pin Configuration Standard Mode

Table 3. 44-Pin PLCC Pin Identification

Pin No	Symbol	Function	Direction
1-2	GND	Ground	
3-4	P12-P13	Port 1, Pins 2,3	Input/Output
5	P03	Port 0, Pin 3	Input/Output
6-10	P20-P24	Port 2, Pins 0,1,2,3,4	Input/Output
11	DS	Data Strobe	Output
12	NC	No Connection	
13	R/$\overline{W}$	Read/Write	Output
14-16	P25-P27	Port 2, Pins 5,6,7	Input/Output
17-19	P04-P06	Port 0, Pins 4,5,6	Input/Output
20-21	P14-P15	Port 1, Pins 4,5	Input/Output
22	P07	Port 0, Pin 7	Input/Output
23-24	V_{CC}	Power Supply	
25-26	P16-P17	Port 1, Pins 6,7	Input/Output

Table 3. 44-Pin PLCC Pin Identification (Continued)

Pin No	Symbol	Function	Direction
27	XTAL2	Crystal Oscillator	Output
28	XTAL1	Crystal Oscillator	Input
29-31	P31-P33	Port 3, Pins 1,2,3	Input
32	P34	Port 3, Pin 4	Output
33	AS	Address Strobe	Output
34	R//RL	ROM/ROMless select Input	
35	RESET	Reset	Input
36	P35	Port 3, Pin 5	Output
37	P37	Port 3, Pin 7	Output
38	P36	Port 3, Pin 6	Output
39	P30	Port 3, Pin 0	Input
40-41	P00-P01	Port 0, Pins 0,1	Input/Output
42-43	P10-P11	Port 1, Pins 0,1	Input/Output
44	P02	Port 0, Pin 2	Input/Output

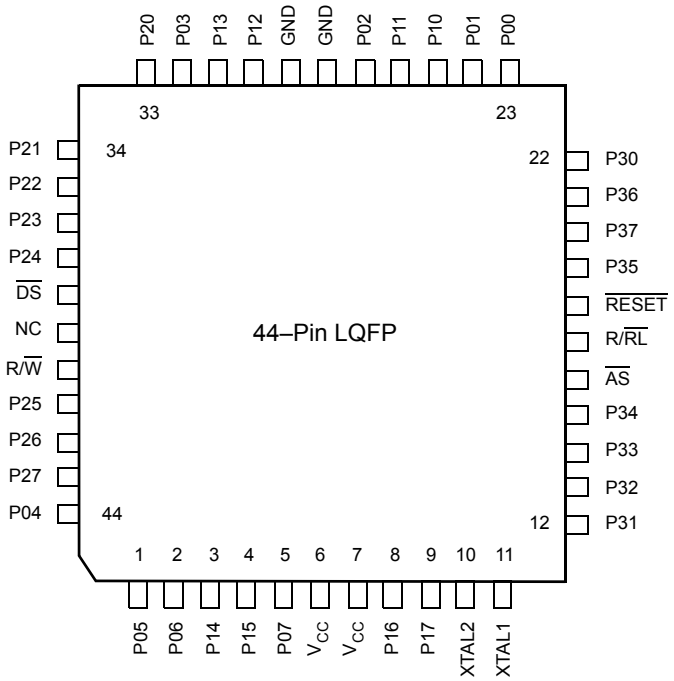

Figure 5. 44-Pin LQFP Pin Configuration Standard Mode

Table 4. 44-Pin LQFP Pin Identification

Pin No	Symbol	Function	Direction
1-2	P05-P06	Port 0, Pins 5,6	Input/Output
3-4	P14-P15	Port 1, Pins 4,5	Input/Output
5	P07	Port 0, Pin 7	Input/Output
6-7	V_{CC}	Power Supply	
8-9	P16-P17	Port 1, Pins 6,7	Input/Output
10	XTAL2	Crystal Oscillator	Output
11	XTAL1	Crystal Oscillator	Input
12-14	P31-P33	Port 3, Pins 1,2,3	Input
15	P34	Port 3, Pin 4	Output
16	AS	Address Strobe	Output
17	R//RL	ROM/ROMless select	Input

Table 4. 44-Pin LQFP Pin Identification (Continued)

Pin No	Symbol	Function	Direction
18	RESET	Reset	Input
19	P35	Port 3, Pin 5	Output
20	P37	Port 3, Pin 7	Output
21	P36	Port 3, Pin 6	Output
22	P30	Port 3, Pin 0	Input
23-24	P00-P01	Port 0, Pin 0,1	Input/Output
25-26	P10-P11	Port 1, Pins 0,1	Input/Output
27	P02	Port 0, Pin 2	Input/Output
28-29	GND	Ground	
30-31	P12-P13	Port 1, Pins 2,3	Input/Output
32	P03	Port 0, Pin 3	Input/Output
33-37	P20-24	Port 2, Pins 0,1,2,3,4	Input/Output
38	DS	Data Strobe	Output
39	NC	No Connection	
40	R/$\overline{W}$	Read/Write	Output
41-43	P25-P27	Port 2, Pins 5,6,7	Input/Output
44	P04	Port 0, Pin 4	Input/Output

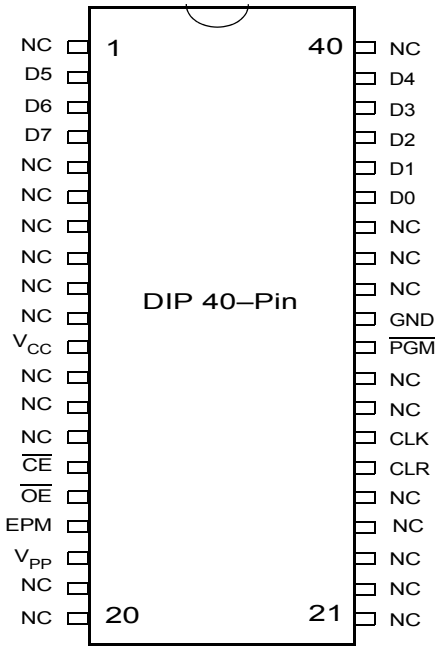

Figure 6. 40-Pin DIP Pin Configuration EPROM Mode

Table 5. 40-Pin DIP Package Pin Identification EPROM Mode

Pin No	Symbol	Function	Direction
1	NC	No Connection	
2-4	D5-D7	Data 5,6,7	Input/Output
5-10	NC	No Connection	
11	V_{CC}	Power Supply	
12-14	NC	No Connection	
15	CE	Chip Select	Input
16	OE	Output Enable	Input
17	EPM	EPROM Prog. Mode	Input
18	V_{PP}	Prog. Voltage	Input
19-25	NC	No Connection	
26	CLR	Clear	Input
27	CLK	Clock	Input
28-29	NC	No Connection	

Table 5. 40-Pin DIP Package Pin Identification EPROM Mode (Continued)

Pin No	Symbol	Function	Direction
30	/PGM	Prog. Mode	Input
31	GND	Ground	
32-34	NC	No Connection	
35-39	D0-D4	Data 0,1,2,3,4	Input/Output
40	NC	No Connection	

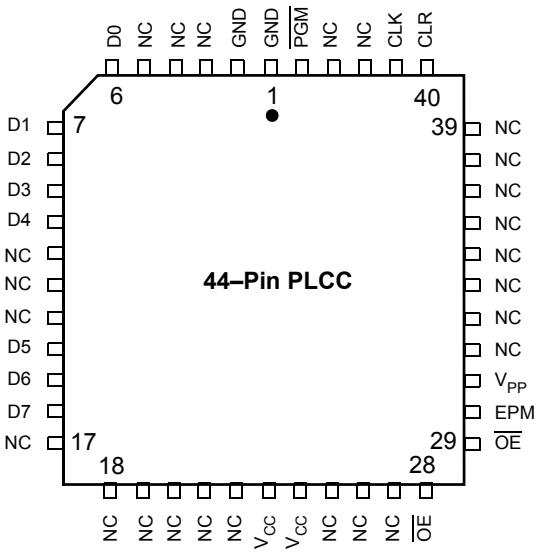

Figure 7. 44-Pin PLCC Pin Configuration EPROM Programming Mode

Table 6. 44-Pin PLCC Pin Configuration EPROM Programming Mode

Pin No	Symbol	Function	Direction
1-2	GND	Ground	
3-5	NC	No Connection	
6-10	D0-D4	Data 0,1,2,3,4	Input/Output
11-13	NC	No Connection	
14-16	D5-D7	Data 5,6,7	Input/Output
17-22	NC	No Connection	
23-24	V_{CC}	Power Supply	
25-27	NC	No Connection	
28	CE	Chip Select	Input
29	OE	Output Enable	Input
30	EPM	EPROM Prog. Mode	Input
31	V_{PP}	Prog. Voltage	Input

Table 6. 44-Pin PLCC Pin Configuration EPROM Programming Mode (Continued)

Pin No	Symbol	Function	Direction
32-39	NC	No Connection	
40	CLR	Clear	Input
41	CLK	Clock	Input
42-43	NC	No Connection	
44	/PGM	Prog. Mode	Input

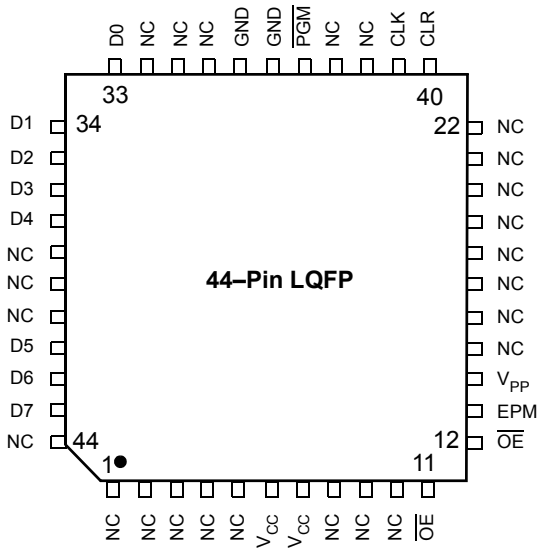

Figure 8. 44-Pin LQFP Pin Configuration EPROM Programming Mode

Table 7. 44-Pin LQFP Pin Identification EPROM Programming Mode

Pin No	Symbol	Function	Direction
1-5	NC	No Connection	
6-7	V_{CC}	Power Supply	
8-10	NC	No Connection	
11	CE	Chip Select	Input
12	OE	Output Enable	Input
13	EPM	EPROM Prog. Mode	Input
14	V_{PP}	Prog. Voltage	Input
15-22	NC	No Connection	
23	CLR	Clear	Input
24	CLK	Clock	Input
25-26	NC	No Connection	
27	/PGM	Prog. Mode	Input
28-29	GND	Ground	
30-32	NC	No Connection	

Table 7. 44-Pin LQFP Pin Identification EPROM Programming Mode (Continued)

Pin No	Symbol	Function	Direction
33-37	D0-D4	Data 0,1,2,3,4	Input/Output
38-40	NC	No Connection	
41-43	D5-D7	Data 5,6,7	Input/Output
44	NC	No Connection	

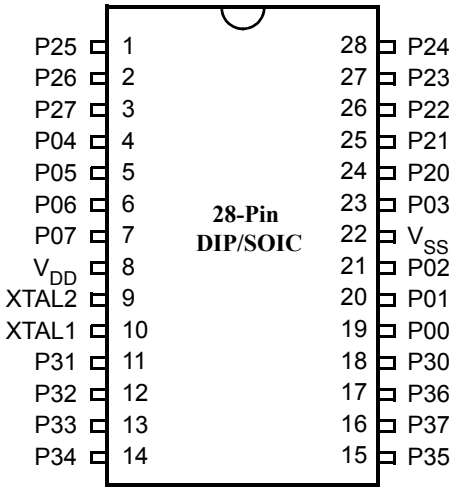

Figure 9. Standard Mode 28-Pin DIP/SOIC Pin Configuration

Table 8. 28-Pin DIP/SOIC/PLCC Pin Identification Standard Mode

Pin No	Symbol	Function	Direction
1-3	P25-P27	Port 2, Pins 5,6,	Input/Output
4-7	P04-P07	Port 0, Pins 4,5,6,7 In/Output	
8	V_{CC}	Power Supply	
9	XTAL2	Crystal Oscillator	Output
10	XTAL1	Crystal Oscillator	Input
11-13	P31-P33	Port 3, Pins 1,2,3	Input
14-15	P34-P35	Port 3, Pins 4,5	Output
16	P37	Port 3, Pin 7	Output
17	P36	Port 3, Pin 6	Output
18	P30	Port 3, Pin 0	Input
19-21	P00-P02	Port 0, Pins 0,1,2	Input/Output
22	V_{SS}	Ground	
23	P03	Port 0, Pin 3	Input/Output
24-28	P20-P24	Port 2, Pins 0,1,2,3,4	Input/Output

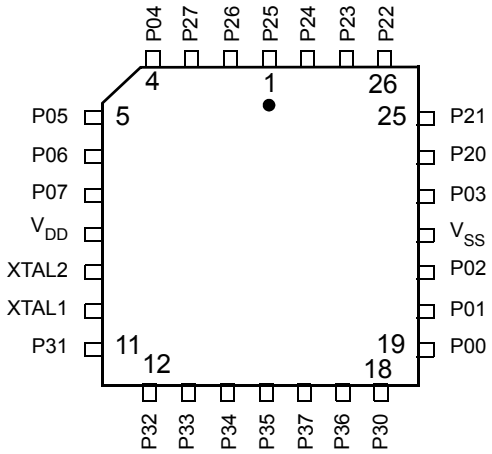

Figure 10. Standard Mode 28-Pin PLCC Pin Configuration

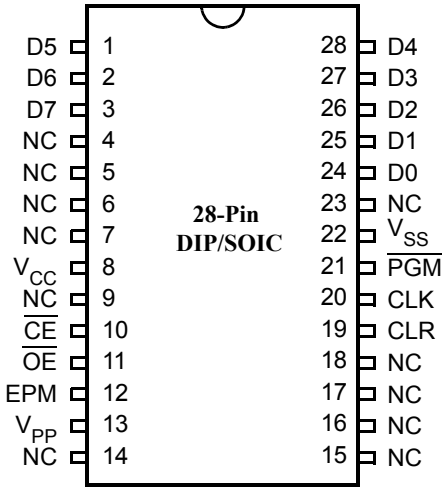

Figure 11. EPROM Programming Mode 28-Pin DIP/SOIC Pin Configuration

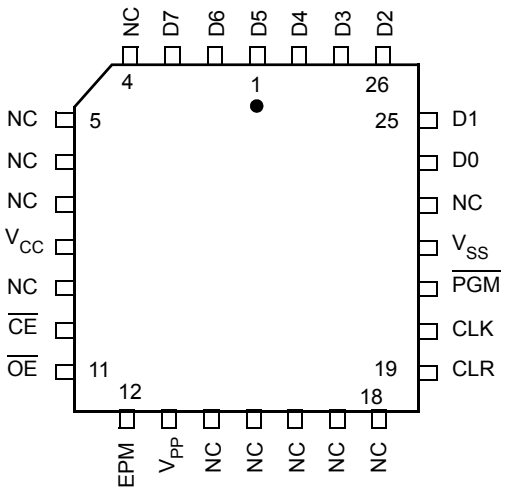

Figure 12. EPROM Programming Mode 28-Pin PLCC Pin Configuration

Table 9. 28-Pin EPROM Pin Identification EPROM Mode

Pin #	Symbol	Function	Direction
1-3	D5-D7	Data 5,6,7	Input/Output
4-7	NC	No Connection	
8	V_{CC}	Power Supply	
9	NC	No connection	
10	CE	Chip Select	Input
11	OE	Output Enable	Input
12	EPM	EPROM Prog. Mode	Input
13	V_{PP}	Prog. Voltage	Input
14-18	NC	No Connection	
19	CLR	Clear	
20	CLK	Clock	
21	/PGM	Prog. Mode	Input
22	V_{SS}	Ground	
23	NC	No Connection	
24-28	D0-D4	Data 0,1,2,3,4	Input/Output

Electrical Characteristics

Absolute Maximum Ratings

Table 10. Absolute Maximum Ratings

Parameter	Min	Max	Units	Notes
Ambient Temperature under Bias	–40	+105	C	
Storage Temperature	–65	+150	C	
Voltage on any Pin with Respect to V_{SS}	–0.6	+7	V	1
Voltage on V_{DD} Pin with Respect to V_{SS}	–0.3	+7	V	
Voltage on XTAL1, P32, P33 and $\overline{\text{RESET}}$ Pins with Respect to V_{SS}	–0.6	V_{DD}+1	V	2
Total Power Dissipation		1.21	W	
Maximum Allowable Current out of V_{SS}		220	mA	
Maximum Allowable Current into V_{DD}		180	mA	
Maximum Allowable Current into an Input Pin	–600	+600	µA	3
Maximum Allowable Current into an Open-Drain Pin	–600	+600	µA	4
Maximum Allowable Output Current Sunk by Any I/O Pin		25	mA	
Maximum Allowable Output Current Sourced by Any I/O Pin		25	mA	
Maximum Allowable Output Current Sunk by $\overline{\text{RESET}}$ Pin		3	mA	

Notes
1. This applies to all pins except XTAL pins and where otherwise noted.
2. There is no input protection diode from pin to V_{DD}.
3. This excludes XTAL pins.
4. Device pin is not at an output Low state.

Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period may affect device reliability.

Total power dissipation should not exceed 1.21 W for the package. Power dissipation is calculated as follows:

$$\text{Total Power Dissipation} = V_{DD} \times [I_{DD} - (\text{sum of } I_{OH}), + \text{sum of } [(V_{DD} - V_{OH}) \times I_{OH}] + \text{sum of } (V_{OL} \times I_{OL})$$

Standard Test Conditions

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (Test Load).

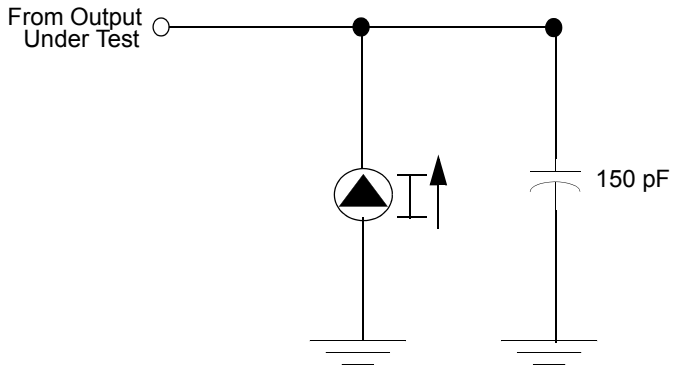

Figure 13. Test Load Diagram

Capacitance

T_A = 25 °C, V_{CC} = GND = 0 V, f = 1.0 MHz, unmeasured pins returned to GND.

Parameter	Min	Max
Input capacitance	0	12 pF
Output capacitance	0	12 pF
I/O capacitance	0	12 pF